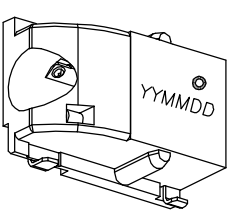
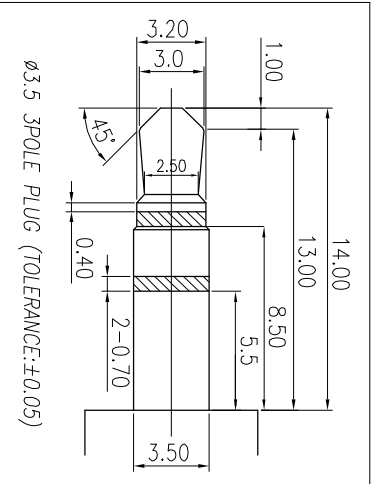
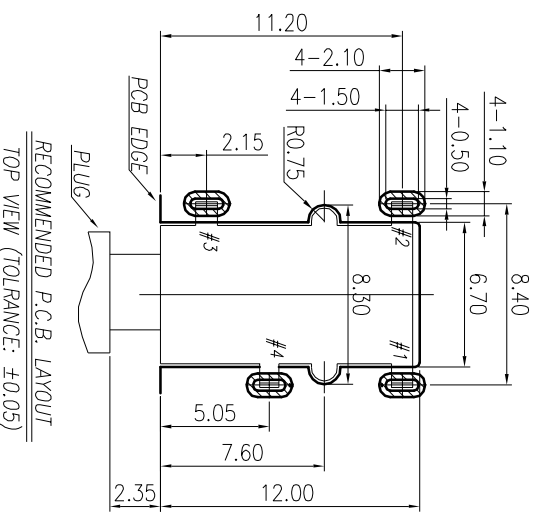
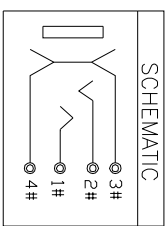
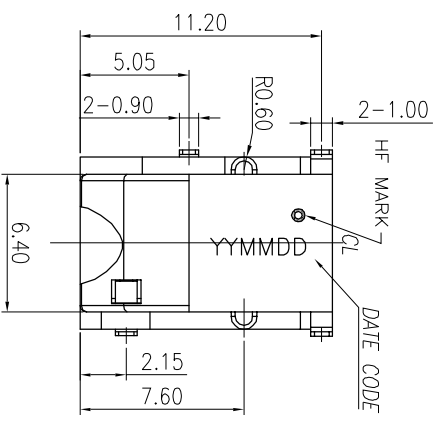
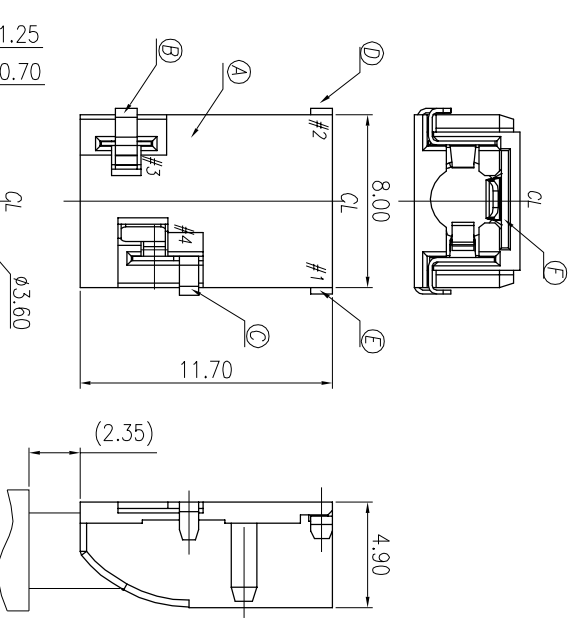


REV.	ECN NO.	OR DESCRIPTION	REVISED	DATE
A	PRODUCT	RELEASE	WEIQG	2011.08.29
B	ECN NO.:	C110363	WEIQG	2011.12.28
C	ECN NO.:	S160867-C	JIE-FU	2016.11.07



- SPECIFICATIONS:**
- ELECTRICAL CHARACTERISTICS:**
 - 1-1. RATING: 12V 1A
 - 1-2. CONTACT RESISTANCE: $30m\Omega$ MAX.
 - 1-3. DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR ONE MINUTE
 - 1-4. INSULATION RESISTANCE: $100M\Omega$ MIN. MEASURED BY 500 VDC
 - MECHANICAL CHARACTERISTICS:**
 - 2-1. INSERTION FORCE : 0.3~3.0 KGF
 - 2-2. WITHDRAWAL FORCE : 0.3~3.0 KGF
 - LIFE TEST: 5,000 CYCLES MIN.
 - OTHER GENERAL SPEC. REFER TO "2S12300-003111F SPEC"
 - TO CONFORM TO THE SINGATRON HARDWARE SUBSTANCE FREE SPEC.
 - HALOGEN FREE PRODUCT IDENTIFICATION MARK:
 - HALOGEN FREE PRODUCT IDENTIFICATION LABEL ON PACKAGING:
 - FOR REFLOW SOLDERING LEAD-FREE PROCESS.
 - PACKAGING: TAPE & REEL.



NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR
F	DUMMY PIN	1	STAINLESS STEEL 0.3t	N/A
E	TIP SPRING	1	COPPER ALLOY 0.2t	Gold Flash On Contact
D	RING SPRING-A	1	COPPER ALLOY 0.2t	Area & Solder tail,
C	RING SPRING-B1	1	COPPER ALLOY 0.2t	All over Nickel Plated.
B	RING SPRING-B	1	COPPER ALLOY 0.2t	
A	BODY	1	HIGH TEMP. THERMOPLASTIC	BLACK

UNLESS OTHERWISE SPECIFIED TOLERANCES

DECIMALS: ANGLES:

X : ± 0.5 X : $\pm 2^\circ$
 X.X : ± 0.3 X.X : $\pm 1^\circ$
 X.XX : ± 0.2

信亨企業股份有限公司
 Singatron Enterprise Co., Ltd.

TITLE: 3.5 ϕ PHONE JACK

DWN: JIE-FU PART NO. 2S12300-003111F
 CHKD: CERRY SCALE 5:1 UNIT: mm
 APVD: LUSSEN SIZE: A4 SHEET: 10F1 REV: C

CUSTOMER COPY